



# **SNS COLLEGE OF TECHNOLOGY**

Coimbatore-35  
An Autonomous Institution

Accredited by NBA – AICTE and Accredited by NAAC – UGC with 'A++' Grade  
Approved by AICTE, New Delhi & Affiliated to Anna University, Chennai

## **DEPARTMENT OF AEROSPACE ENGINEERING**

### **19ASZ401 – 3D PRINTING FOR SPACE COMPONENTS IV YEAR VII SEM**

#### **UNIT-III Photo polymerization and Powder Bed Fusion Process TOPIC: Powder Bed Fusion process parameters**

NAME: Mr.N.Venkatesh., M.Tech  
Assistant Professor  
Aerospace Engineering  
SNS College of Technology





# Process parameters in PBF

## ▶ **LBM**

- ▶ Power of laser source
- ▶ scan speed
- ▶ hatch distance
- ▶ laser tracks
- ▶ thickness of powdered layer

## ▶ **EBM**

- ▶ Electron beam power,
- ▶ Current
- ▶ diameter of focus
- ▶ powder pre-heat temperature
- ▶ layer thickness



# Porosity in PBF parts

## ► Types of pores in PBF parts

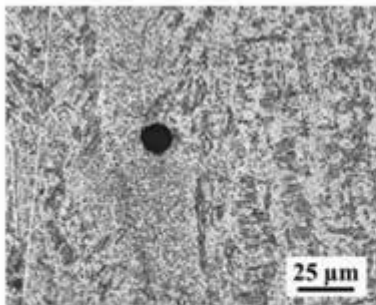


Fig.4 pore due to trapped gas in SLM processed TI-6Al-4V

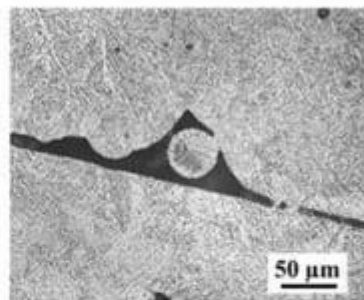
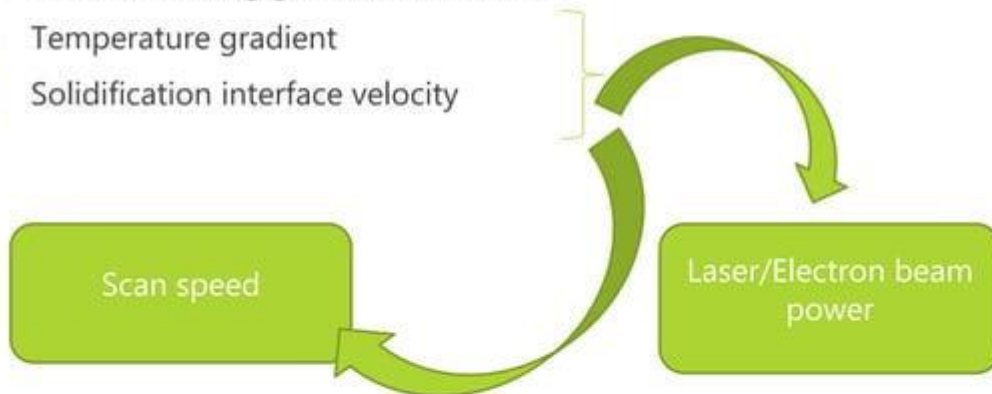


Fig.5 pore due to insufficient heating in SLM processed TI-6Al-4V



# PBF Microstructure

- ▶ Factors affecting grain microstructure
  - Temperature gradient
  - Solidification interface velocity





# Laser Scan Strategy in AM

- ▶ laser power
- ▶ Laser spot size
- ▶ scan speed,
- ▶ hatch distance

	Layer n	Layer n+1
All X		
All Y		
XYA		
CB		
CBNO		

Fig.6 Schematic of laser scanning strategies used



# Density variations with laser power and scanning velocity in SLM

		Scanning velocity		
		1300 mm/s	1700 mm/s	2100 mm/s
Laser power	500 W	 $\rho=99.8\%$	 $\rho=98.5\%$	 $\rho=98.3\%$
	700W	 $\rho=99.8\%$	 $\rho=98.9\%$	 $\rho=98.4\%$
	900 W	 $\rho=99.8\%$	 $\rho=99.6\%$	 $\rho=99.5\%$

Fig.8 Densities by means of cross sections of SLM samples depending on scanning velocity and laser power



# Effect of scanline spacing on Density in SLM

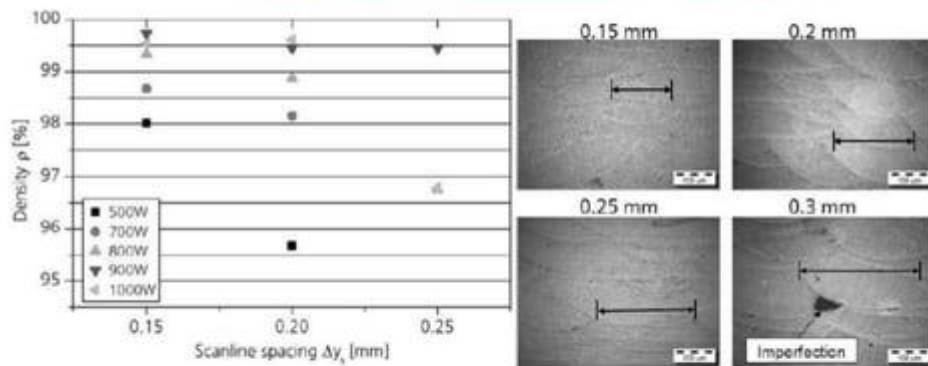


Fig.9 . Density depending on scanline spacing,  $P_L = 900$  W,  $V_s = 1700$  mm/s,  $D_s = 50$   $\mu$ m (left), Cross sections of SLM samples built with different scanline spacings (right)



# Hardness variations with scanning velocity and scanline spacing

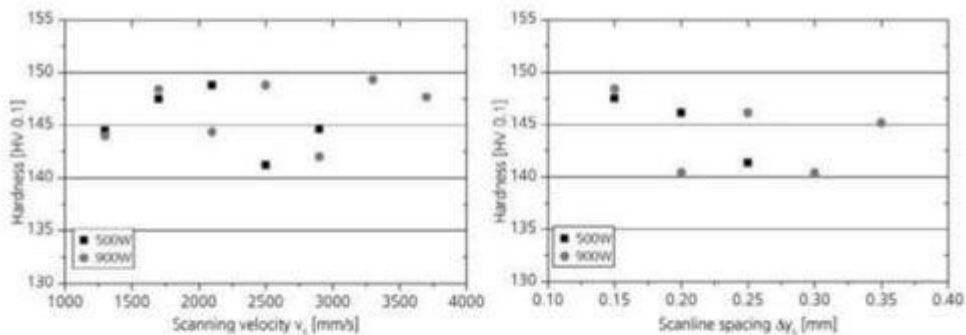


Fig.10 . Hardness depending on scanning velocity (left), Hardness depending on scanline spacing (right)





## Multi-material PBF

- A critical requirement **in multiple material SLM** is **to deposit at least two discrete powder materials within one layer.**
- 316L **stainless steel**, In718 **nickel alloy** and Cu10Sn **copper alloy**
- combining powder-bed spreading, point-by-point multiple nozzles ultrasonic dry powder delivery, and point-by-point single layer powder removal to realize multiple material fusion within the same layer and across different layers



# Multi-material PBF

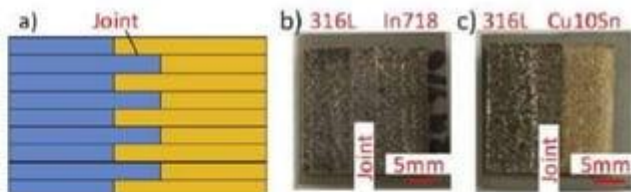
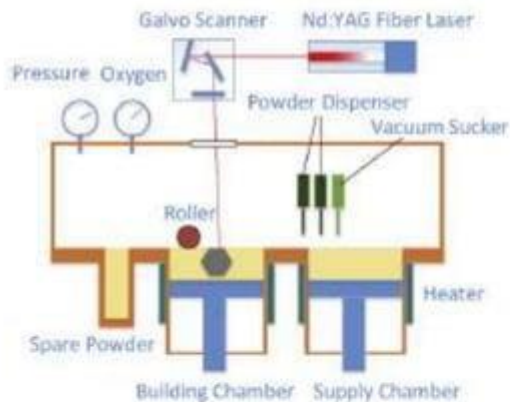


Fig.11 Multi-material PBF specimen

Fig.10 Schematic of multi-material PBF equipment



# Materials in DED

- ▶ Titanium alloys
- ▶ Stainless steel
- ▶ Tool steels
- ▶ Aluminium alloys
- ▶ Refractory metals (tantalum, tungsten, niobium)
- ▶ Superalloys (Inconel, Hastelloy)
- ▶ Nickel
- ▶ Copper



# Process parameters in laser DED

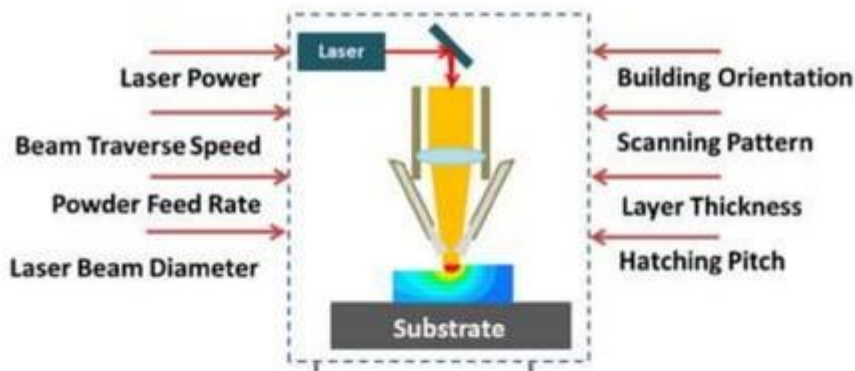
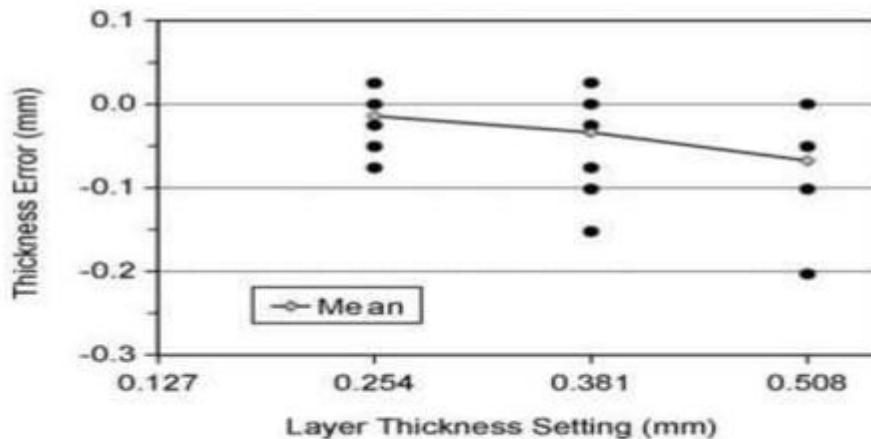


Fig.13 Process parameters in laser DED

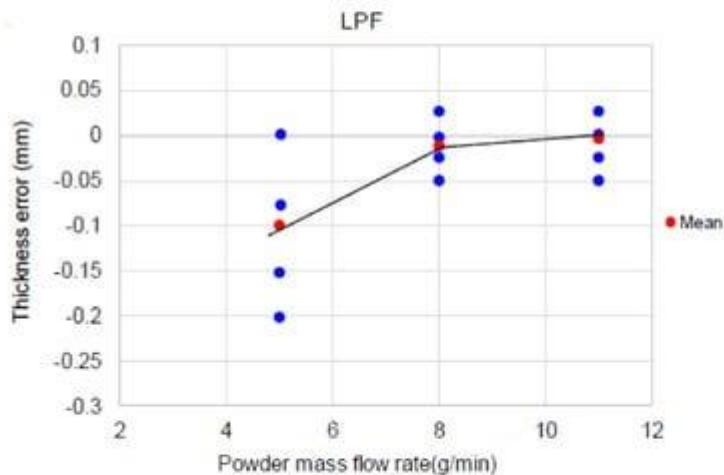


# Effect of layer thickness on thickness error



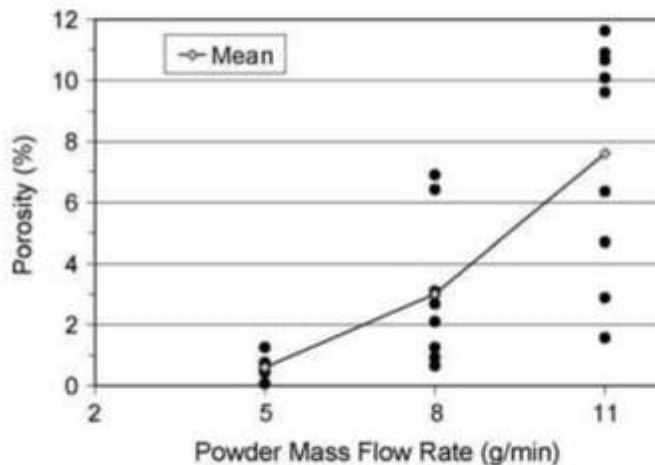


# Effect of powder mass flow rate on thickness error





# Influence of powder mass flow rate on porosity





# Comparison of DED and PBF

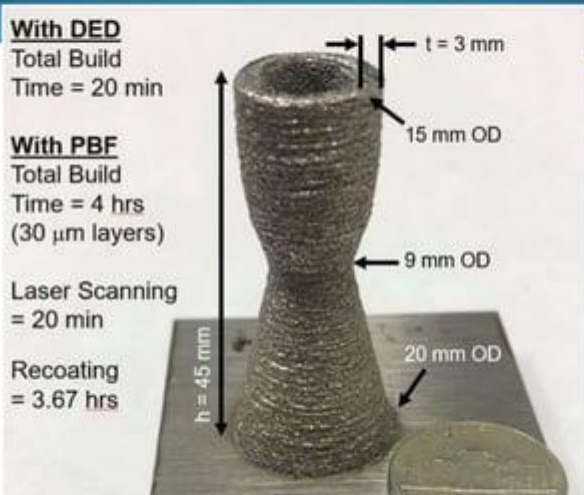


Fig.14 Build-time comparisons for laser-based DED and PBF for a small titanium nozzle. The material is Ti-6Al-4V.





# Process parameters in binder jetting

- ▶ Drying time
- ▶ Printing saturation
- ▶ Powder characteristics
- ▶ Layer thickness
- ▶ Binder burnout and sintering
- ▶ Sintering additives
- ▶ Infiltration of nanoparticles into porous BJ printed parts



# Post processing in binder jetting

- ▶ The main drawback of metal Binder Jetting parts are their mechanical properties, which are not suitable for high-end applications.
- ▶ **Reason** : printed parts basically consist of metal particles bound together with a **polymer adhesive**.
  1. **Infiltration**
  2. **Sintering**



## Post processing in binder jetting

- ▶ **Infiltration:** After printing, the part is placed in a furnace, where the binder is burnt out leaving voids. At this point, the part is approximately 60% porous. **Bronze is then used to infiltrate the voids** via capillary action, resulting in parts with low porosity and good strength.
- ▶ **Sintering:** After printing is complete, the parts are placed in a high temperature furnace, where the **binder is burnt out** and the remaining metal particles are sintered (bonded) together, resulting in parts with very low porosity.



# Advancements in binder jetting

- ▶ Binder jetting additive manufacturing with a particle-free **metal ink** as a binder precursor
- ▶ using **metal nanoparticles** ink as a binder to replace polymer adhesives
- ▶ **Metal-Organic-Decomposition (MOD) ink**
- ▶ MOD ink contains an organometallic compound formed by introducing ligands (complexing agents) to metal salts



# Process Parameters in UAM

- ▶ Weld speed
- ▶ Sonotrode oscillation amplitude
- ▶ Weld pressure
- ▶ Anvil temperature
- ▶ Sonotrode topology



# THANK YOU